

SEMICONDUCTOR TM

NDS8434A Single P-Channel Enhancement Mode Field Effect Transistor

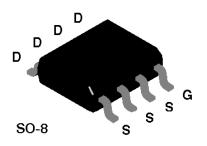
General Description

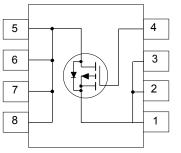
Features

SO-8 P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

• -7.8 A, -20 V. $R_{DS(ON)} = 0.024 \ \Omega \ @ V_{GS} = -4.5 \ V R_{DS(ON)} = 0.032 \ \Omega \ @ V_{GS} = -2.5 V.$

- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.





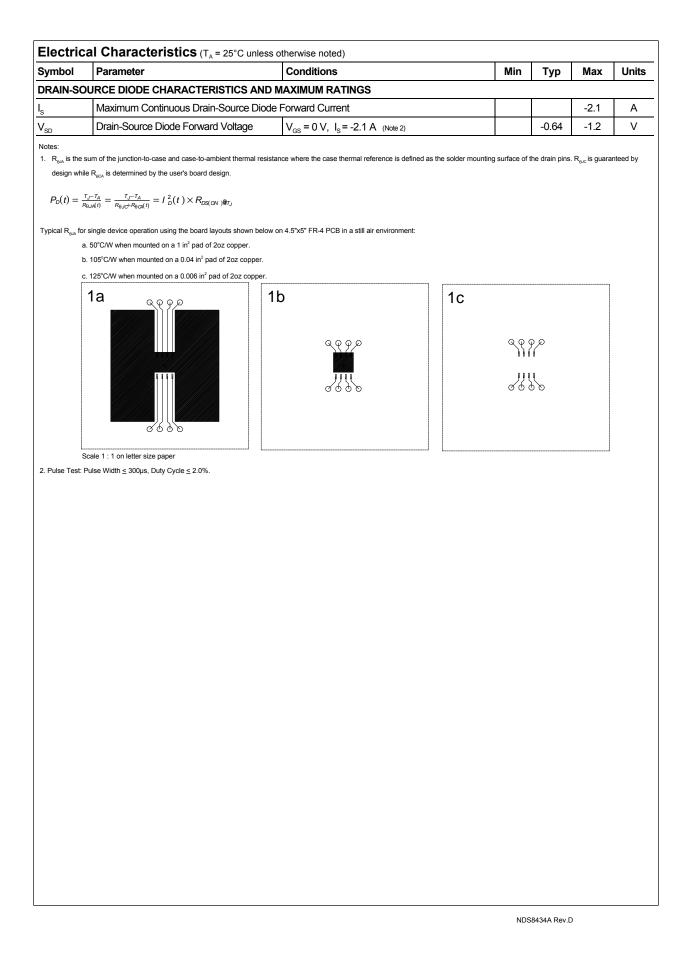
Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

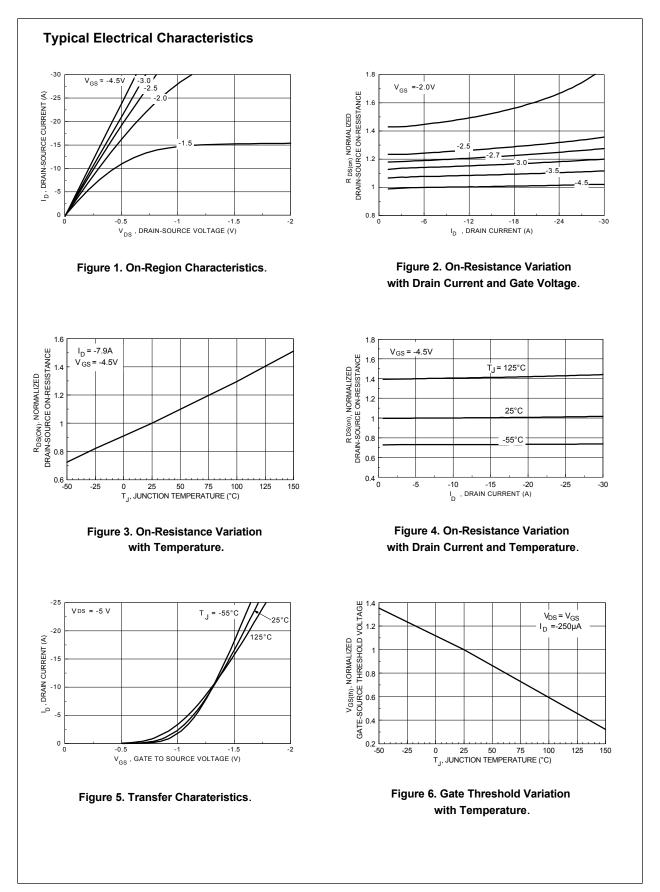
Symbol	Parameter		NDS8434A	Units
V _{DSS}	Drain-Source Voltage Gate-Source Voltage		-20	V
V _{GSS}			±8	V
I _D	Drain Current - Continuous - Pulsed	(Note 1a)	-7.8	A
			-25	
P _D	Maximum Power Dissipation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
Γ _J ,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS	·		
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)		50	°C/W
R _{ejc}	Thermal Resistance, Junction-to-Case (Note 1)		25	°C/W

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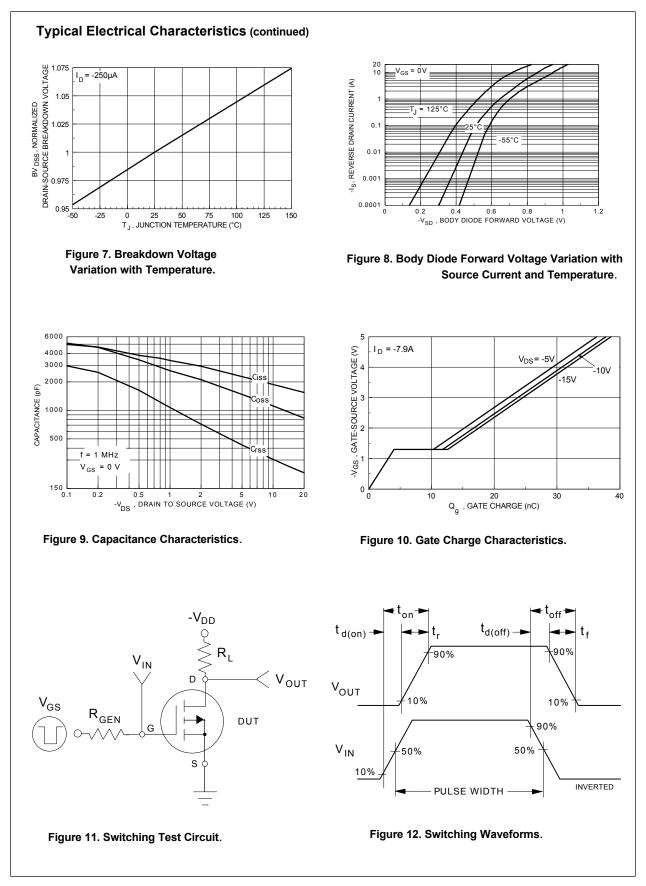
March 1997

Symbol	Parameter	Conditions		Min	Тур	Мах	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V				-1	μA
			T _J =55°C			-10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
	Gate - Body Leakage, Reverse	V _{GS} = -8 V, V _{DS} = 0 V				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-0.4	-0.51	-1	V
			T _J = 125°C	-0.3	-0.32	-0.8	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, \ \text{I}_{D} = -7.9 \text{ A}$			0.021	0.024	Ω
			T _J = 125°C		0.032	0.043	
		V_{GS} = -2.5 V, I _D = -7.2 A			0.027	0.032	
I _{D(on)}	On-State Drain Current	$V_{GS} = -4.5 V, V_{DS} = -5 V$		-25			А
		V_{GS} = -2.5 V, V_{DS} = -5 V		-10			
g _{FS}	Forward Transconductance	$V_{\rm DS}$ = -4.5 V, I _D = -7.9 A			28		S
DYNAMIC	CHARACTERISTICS			-		-	
C _{iss}	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$ f = 1.0 MHz			1730		pF
C _{oss}	Output Capacitance				1100		pF
C _{rss}	Reverse Transfer Capacitance				300		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Tum - On Delay Time	$V_{DD} = -5 V, I_{D} = -1 A,$ $V_{GEN} = -4.5 V, R_{GEN} = 6 \Omega$			13	25	ns
ţ	Turn - On Rise Time				38	70	ns
t _{D(off)}	Turn - Off Delay Time				210	300	ns
t _r	Turn - Off Fall Time				78	150	ns
Q _g	Total Gate Charge	$V_{DS} = -10 V,$			35	55	nC
Q _{gs}	Gate-Source Charge	$I_{\rm D}^{\rm LS}$ = -7.9 A, $V_{\rm GS}$ = -4.5 V			3.8		nC
Q_{gd}	Gate-Drain Charge				8.2		nC

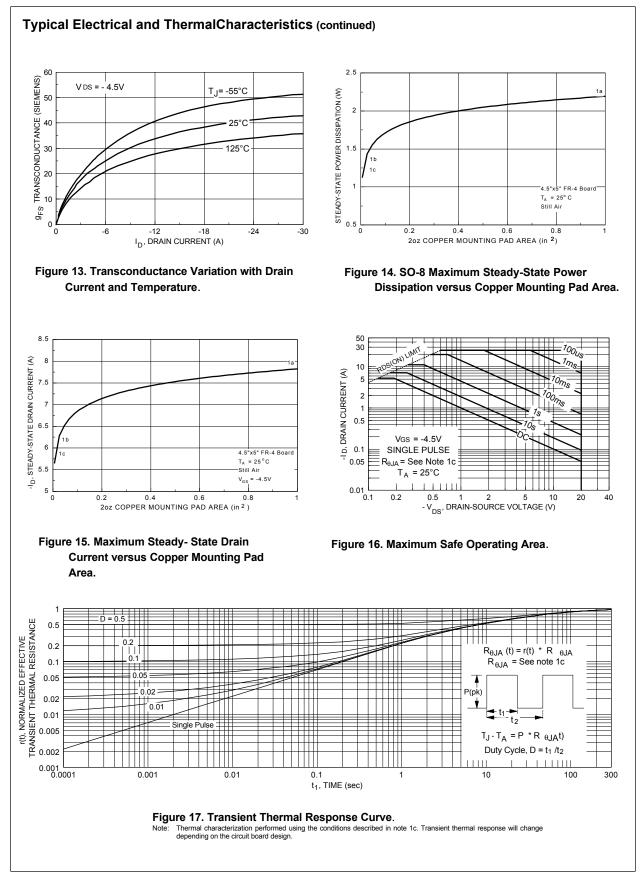




NDS8434A Rev.D



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